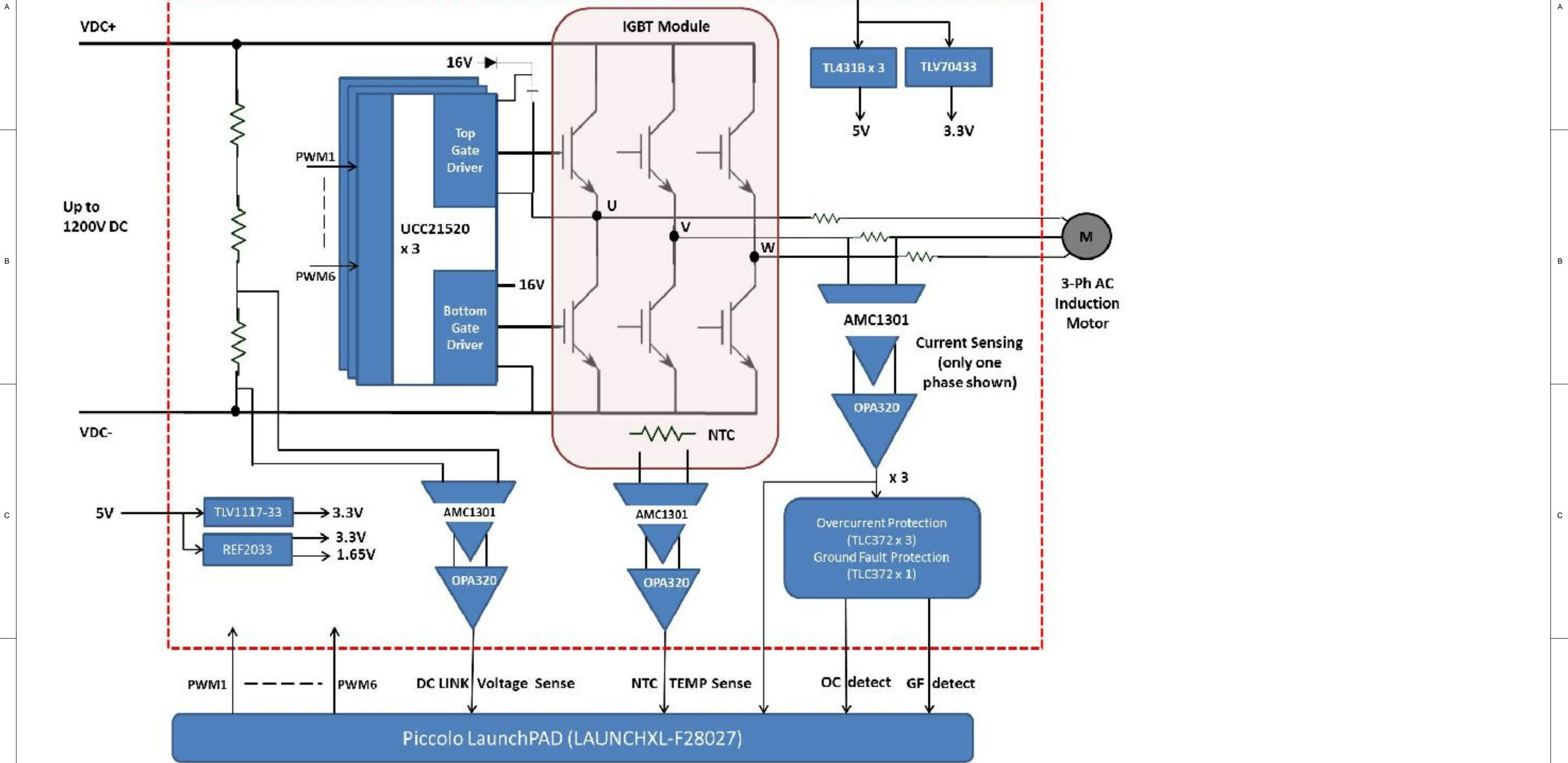


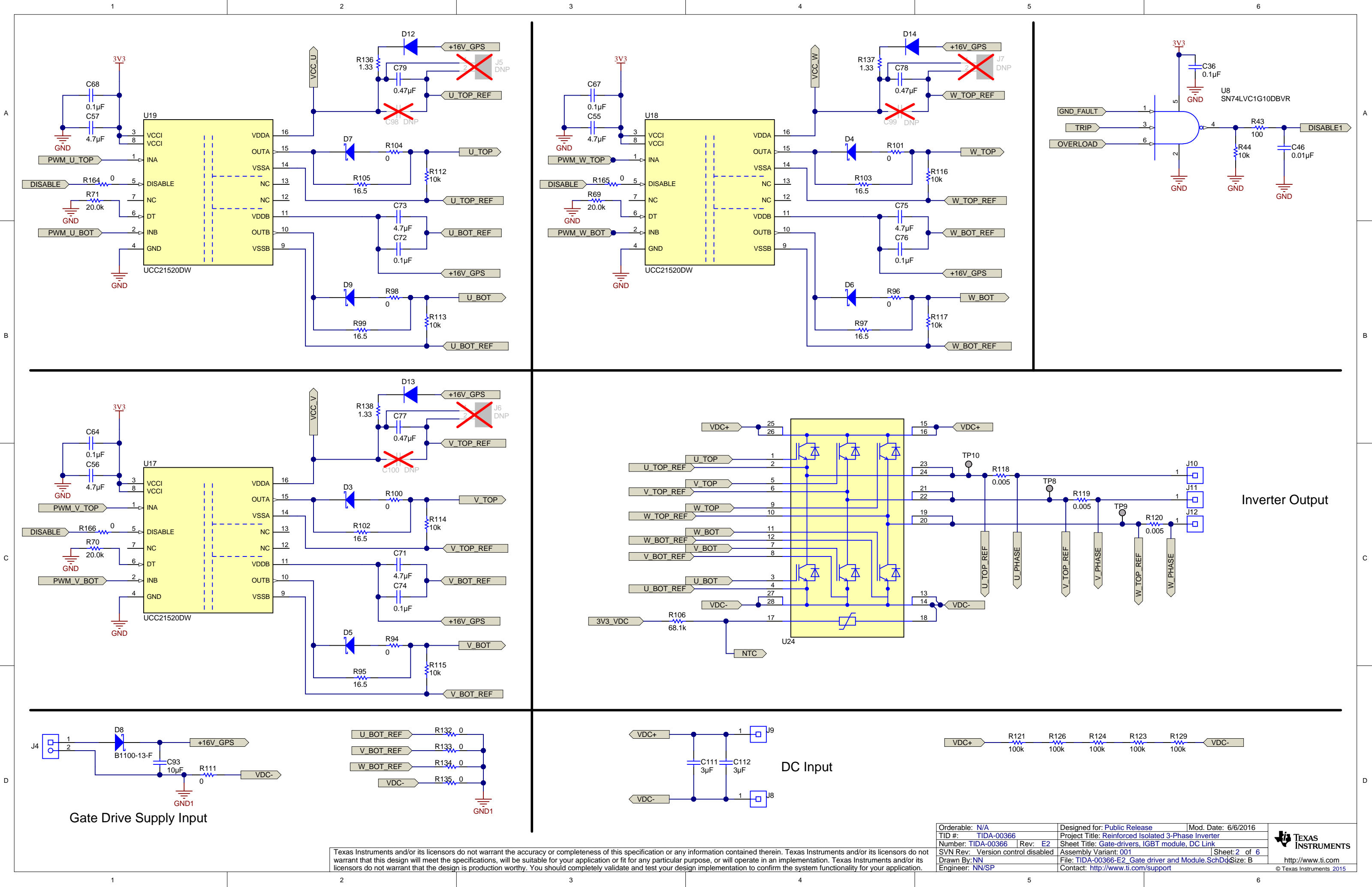
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N/A	N/A	N/A	N/A	N/A	

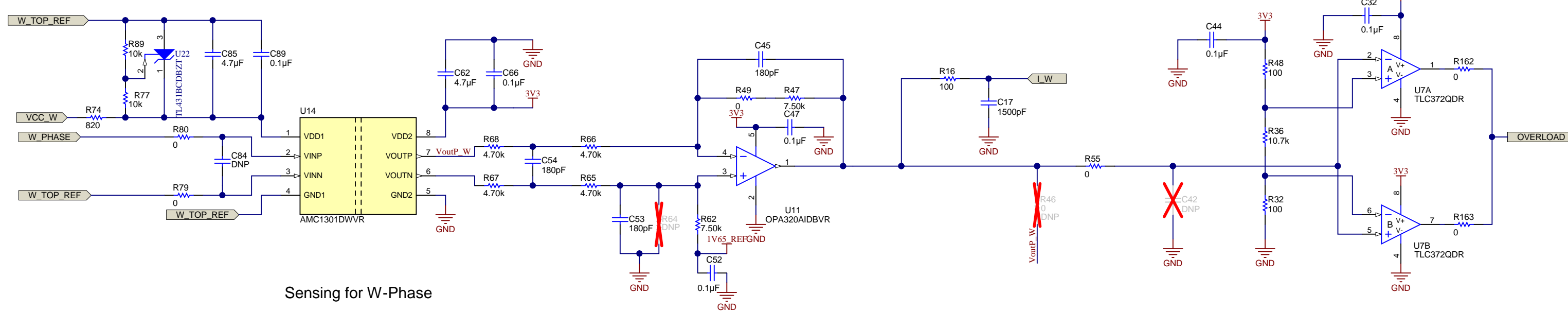
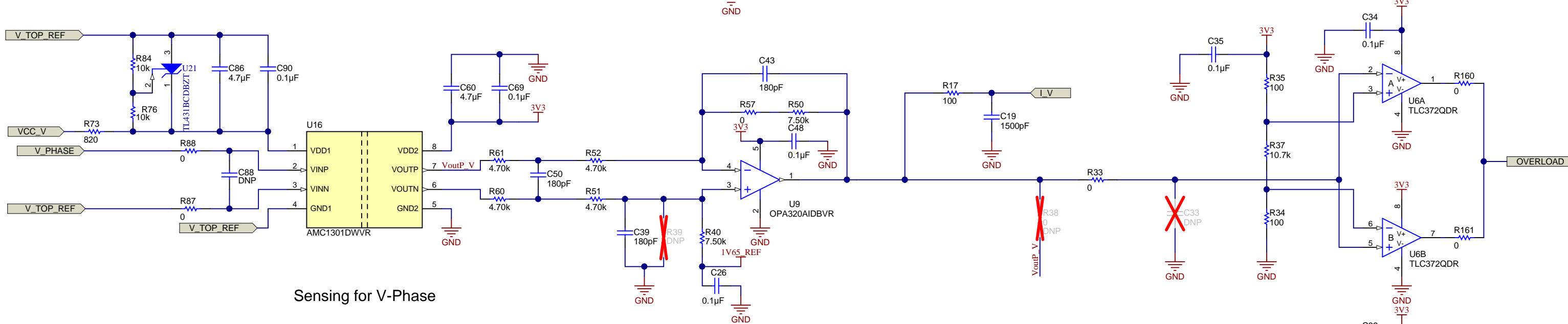
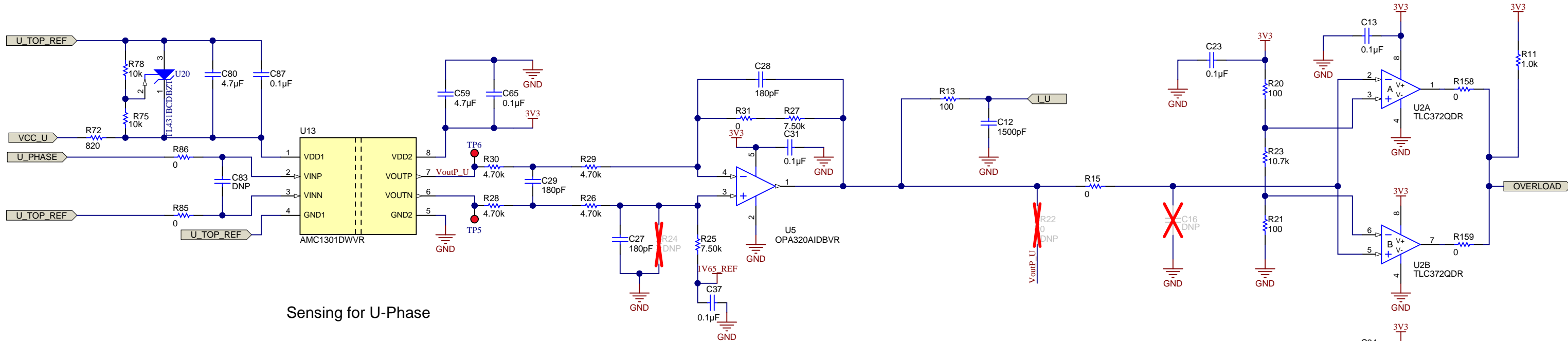


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TID #: TIDA-00366	Project Title: Reinforced Isolated 3-Phase Inverter	
Number: TIDA-00366	Rev: E2	Sheet Title: Block Diagram
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 6
Drawn By: NN	File: TIDA-00366-E2_CoverSheet.SchDoc	Size: B
Engineer: NN/SP	Contact: http://www.ti.com/support	

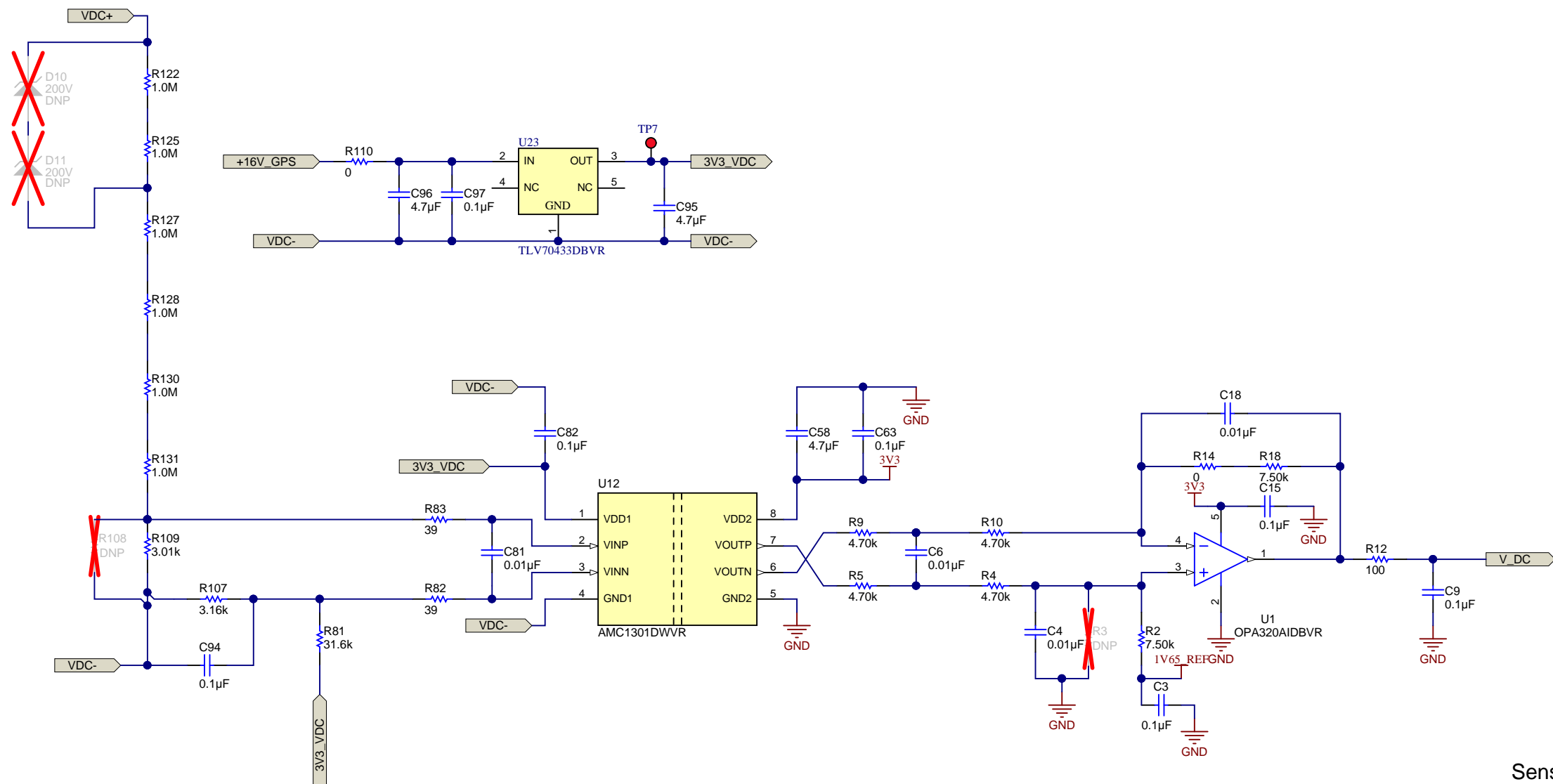




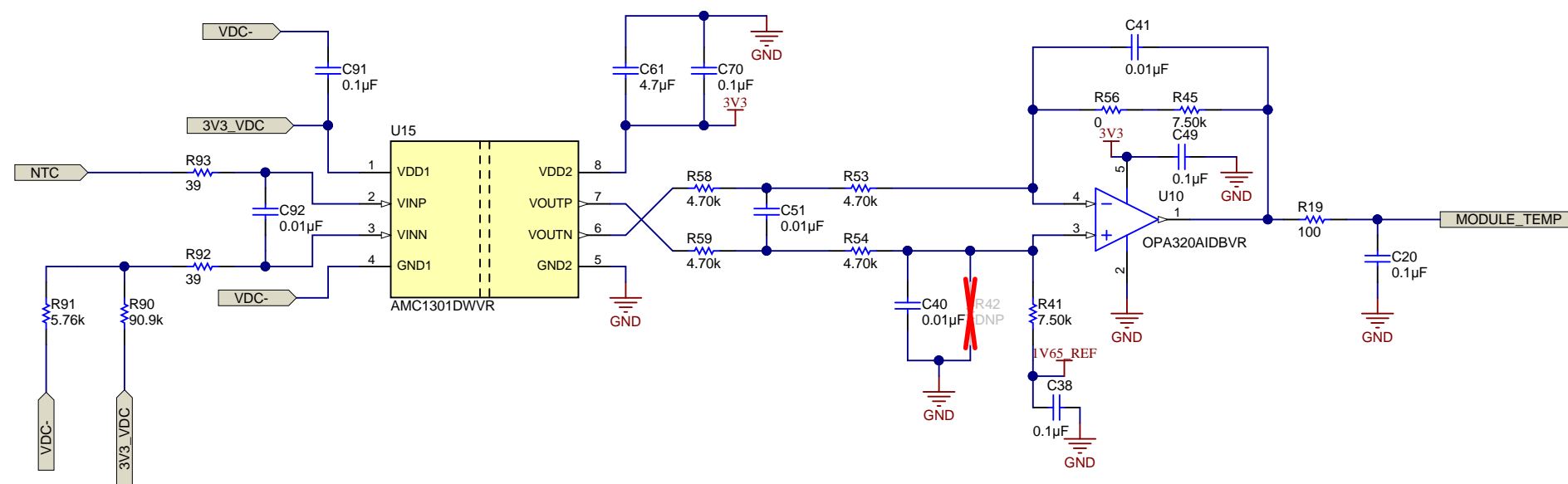
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Number: TIDA-00366	Rev: E2	Sheet Title: Current Sense
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 6
Drawn By: NN	File: TIDA-00366-E2_Current_sense.SchDoc	Size: B
Engineer: NN/SP	Contact: http://www.ti.com/support	© Texas Instruments 2015





Sensing for DC Link Voltage

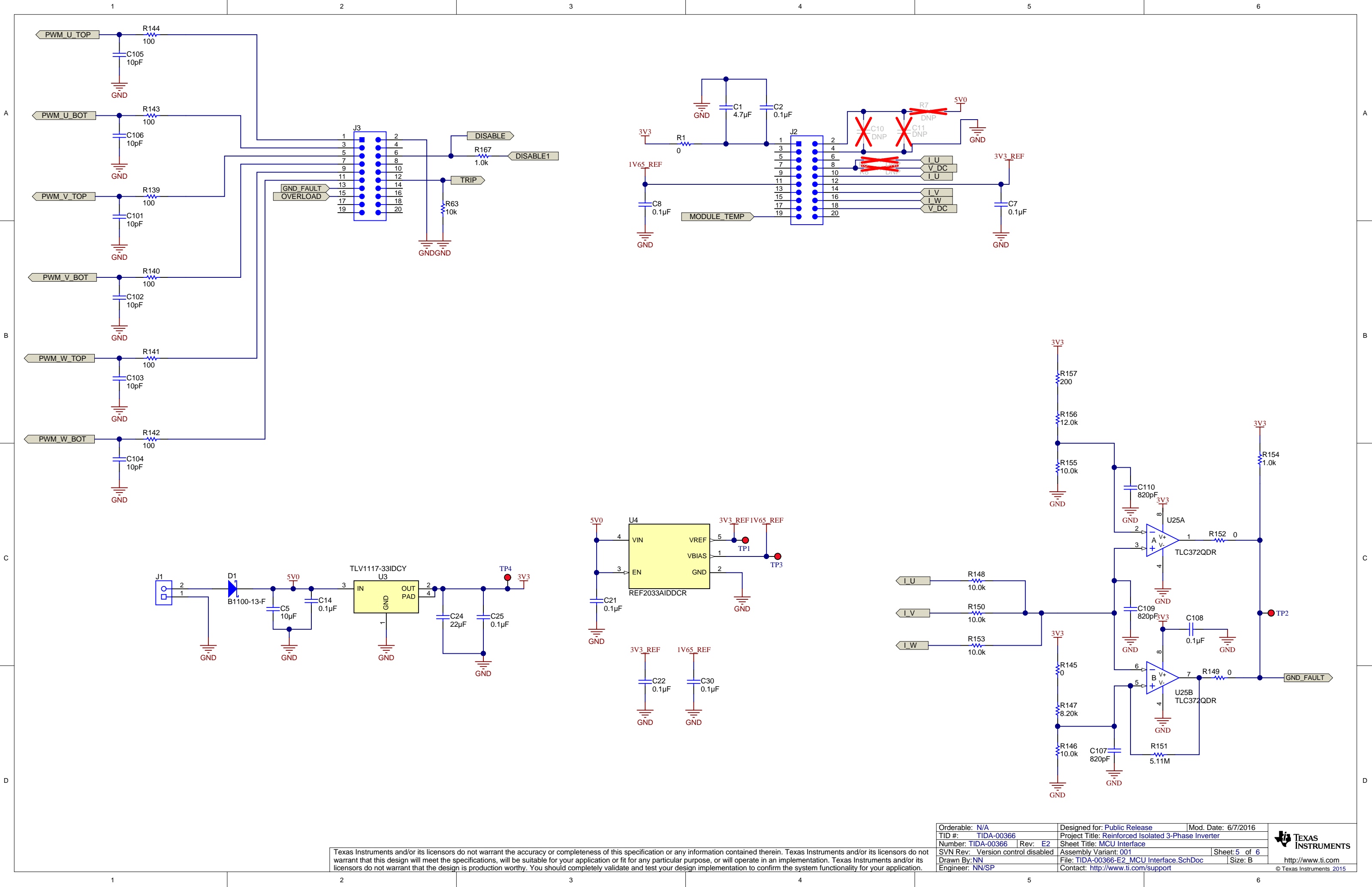


Sensing for Module Temperature

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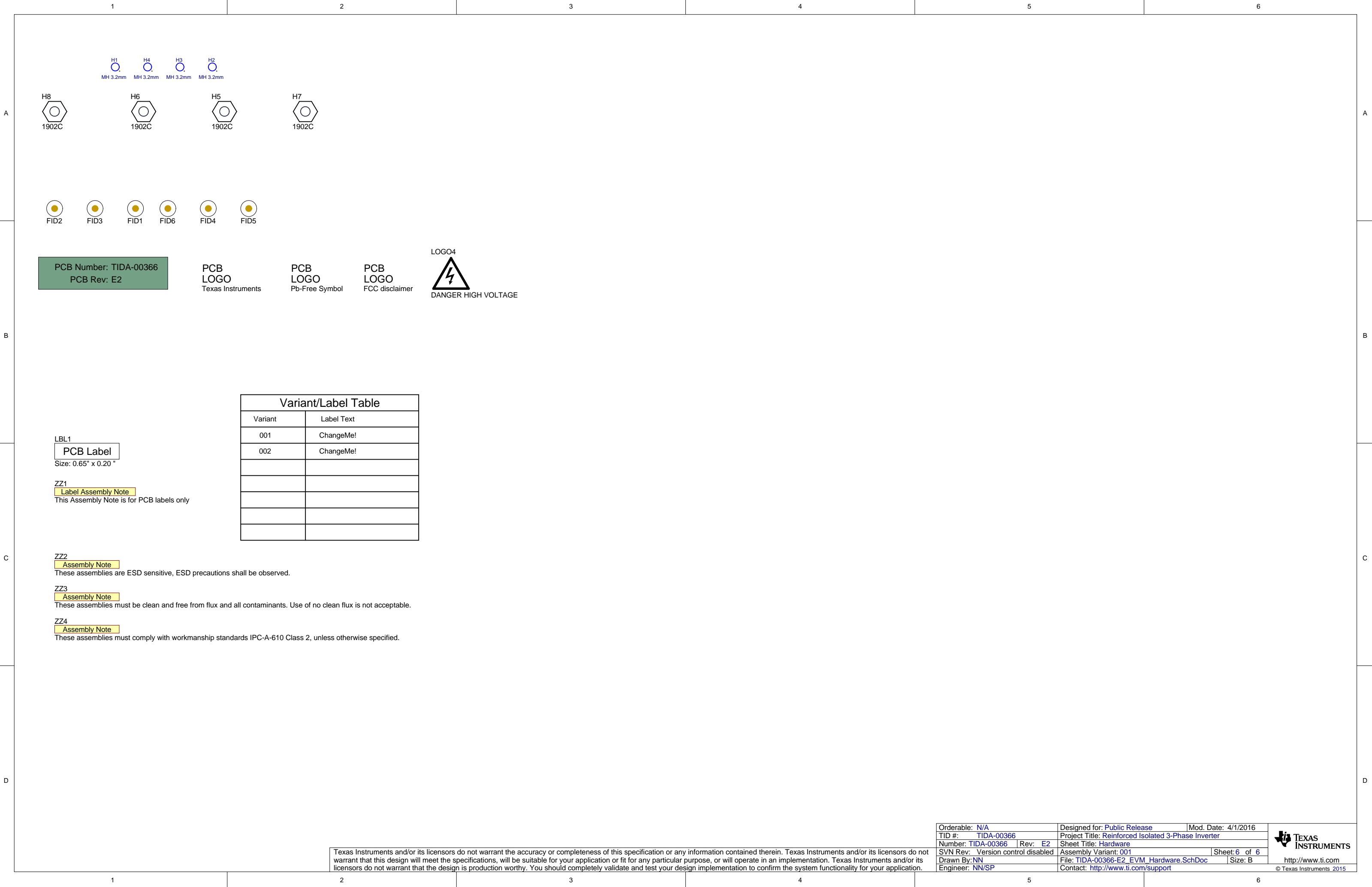
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SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 4 of 6
Drawn By: NN	File: TIDA-00366-E2_DC BUS and TEMP Sense.Sch	Size: B
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